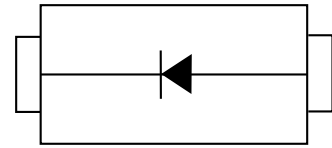


Feature

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives


Mechanical Characteristics

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg 0.00086oz

Absolute maximum rating@25°C

Parameter	Symb ol	PM1	PM2	PM3	PM4	PM5	PM6	PM7	Unit s
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at Ta = 65 °C	I _{F(AV)}	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30							A
Maximum Instantaneous Forward Voltage at 1A	V _F	1.1							V
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta =125 °C	I _R	5 50							μA
Typical Junction Capacitance ¹⁾	C _j	4							pF
Typical Thermal Resistance ²⁾	R _{θJA}	180							°C /W
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150							°C

Typical Characteristics

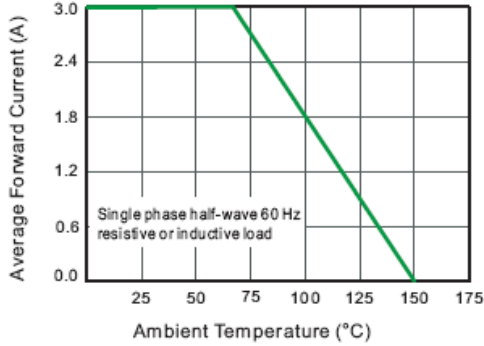


Fig.1 Forward Current Derating Curve

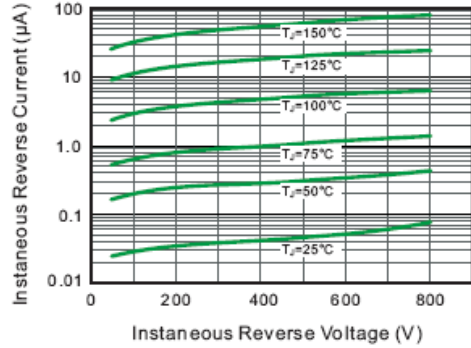


Fig.2 Typical Instantaneous Reverse Characteristics

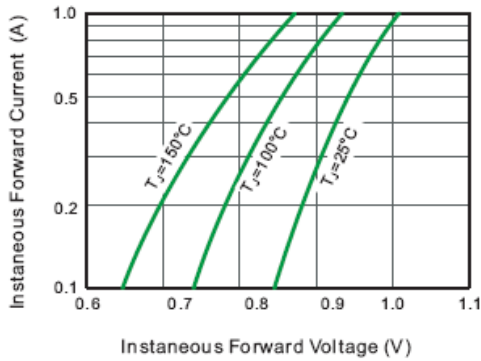


Fig.3 Typical Forward Characteristic

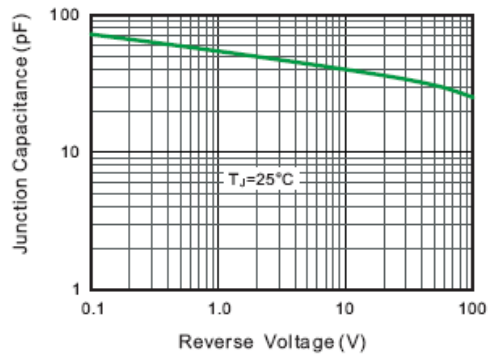
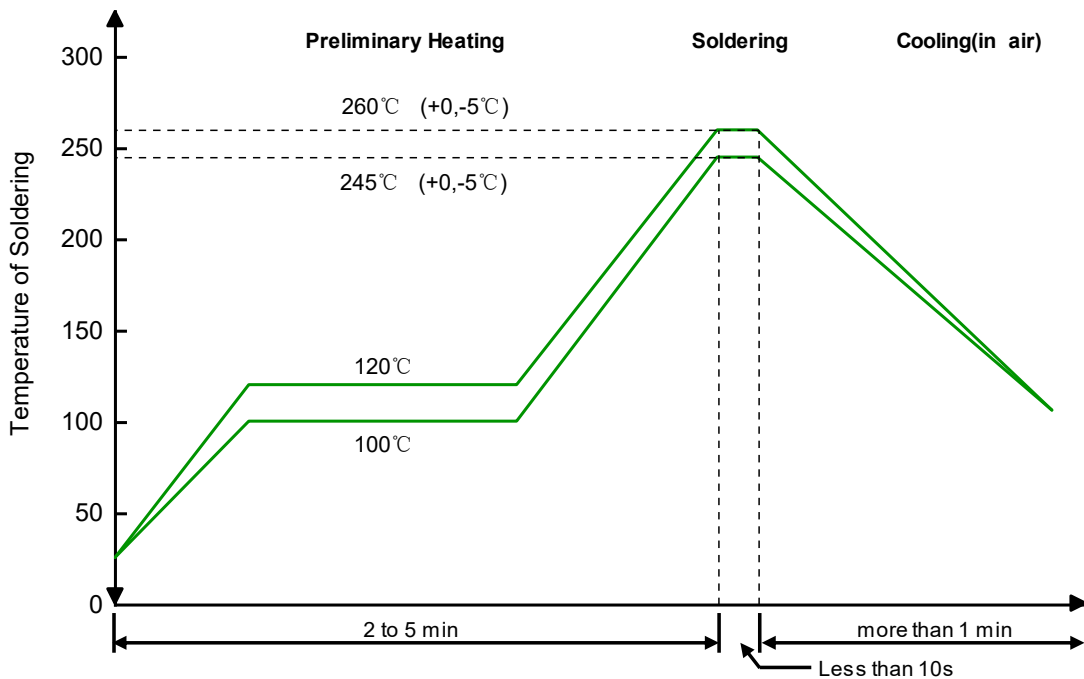


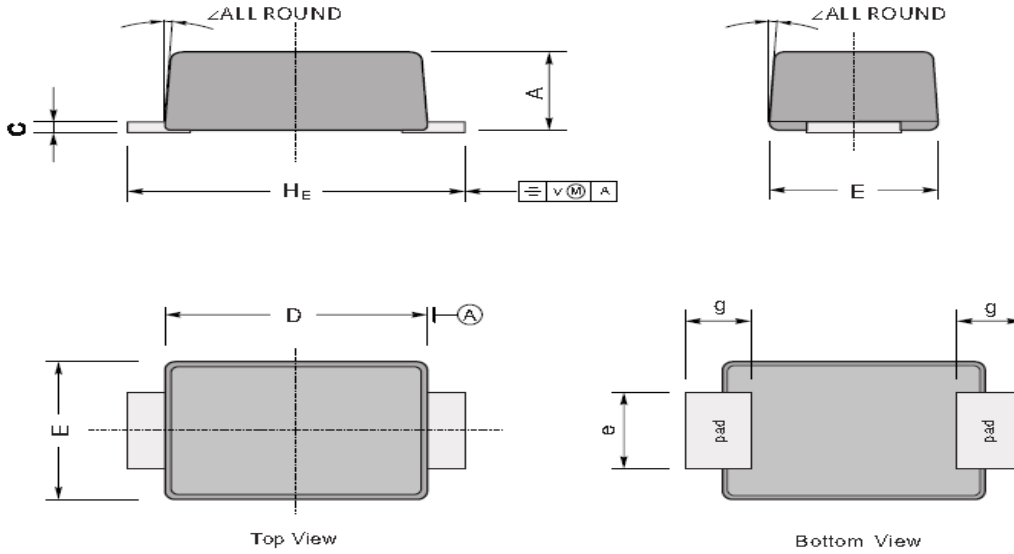
Fig.4 Typical Junction Capacitance

Solder Reflow Recommendation



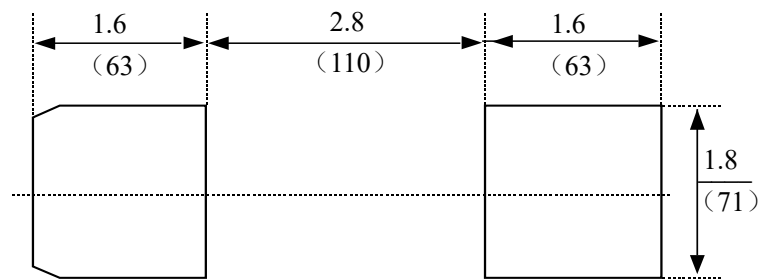
Remark: Pb free for 260°C; Pb for 245°C.

Product dimension (SMAF)



UNIT		A	C	D	E	e	g	HE	∠
mm	max	1.3	0.23	3.7	2.7	1.6	1.3	4.9	7°
	min	0.9	0.18	3.3	2.4	1.3	1.0	4.4	
mil	max	51	9.1	146	106	63	51	193	
	min	35	7.1	130	94	51	39	173	

The recommended mounting pad size



Unit: $\frac{\text{mm}}{\text{(mil)}}$

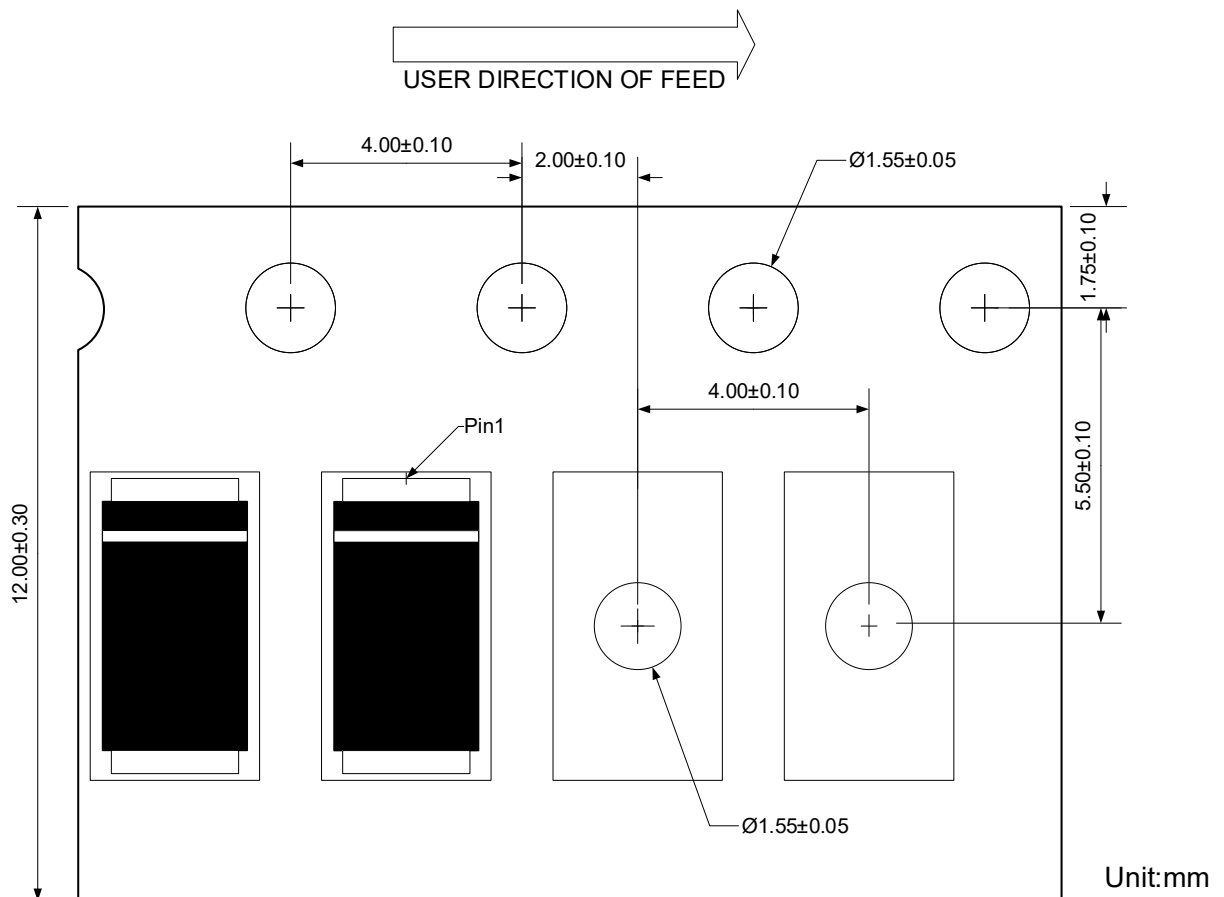
Ordering information

Device	Marking
PM1	M1
PM7	M7


Ordering information

Device	Package	Reel	Shipping
PM1-PM7	SMAF	7"	3000/ Tape & Reel

Load with information




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